



Receipt
#3

Patent

Attorney's Docket No.: 042390.P12075

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re the Patent Application of:

Stefan Hau-Riege
R. Scott List

Examiner: Not Yet Assigned

Art Unit: 2812

Application No.: 10/001,305

Filed: October 30, 2001

Title: METHOD OF MAKING A
SEMICONDUCTOR DEVICE THAT
HAS COPPER DAMASCENE
INTERCONNECTS WITH
ENHANCED ELECTROMIGRATION
RELIABILITY

COPY OF PAPERS
ORIGINALLY FILED

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REQUEST FOR CORRECTION OF FILING RECEIPT

Sir:

On the Filing Receipt for the above referenced patent application the filing date and applicants were recorded incorrectly as follows:

Filing Date: October 30, 2001
Applicant(s): R. Scott List, Beaverton, OR

The correct filing date and applicants are as follows:


Filing Date: November 30, 2001
Applicant(s): Stefan Hau-Riege, Milpitas, CA
R. Scott List, Beaverton, OR

Please have the Filing Receipt changed to reflect the correct filing date and applicants. Enclosed is a copy of the incorrect Filing Receipt and with the correct filing date and applicants in red. Enclosed is a copy of the Express Mail Receipt which indicates that the Application was filed on November 30, 2001. Also enclosed are copies of the executed Declarations and Power of Attorney which indicates that the Applications are Stefan Hau-Riege of Milpitas, CA and R. Scott List of Beaverton, OR.

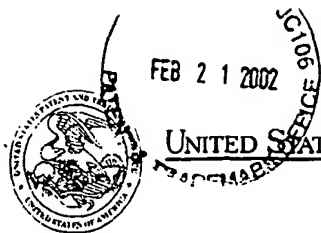
Applicant respectfully requests a corrected Filing Receipt. If there are any additional charges, please charge Deposit Account No. 50-0221. This paper is being submitted in duplicate.

Respectfully submitted,
BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN

Date: February 11, 2002


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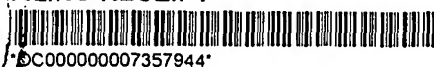
APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO.	DRAWINGS	TOT CLAIMS	IND CLAIMS
10/001,305	10/30/2001 11/30/01	2812	896	042390.P12075	6	24	4

CONFIRMATION NO. 2401

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Date Mailed: 01/25/2002

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s) *Stefan Hau-Riege, Milpitas, CA*
R. Scott List, Beaverton, OR;

D mestic Priority data as claimed by applicant

Foreign Applications

If Required, Foreign Filing License Granted 01/24/2002

Projected Publication Date: 05/01/2003

Non-Publication Request: No

Early Publication Request: No

Title

Method of making a semiconductor device that has copper damascene interconnects with enhanced electromigration reliability

Preliminary Class

438

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